Attorney Docket No. 12768/3

DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 C.F.R. §1.63)

As a below named inventor, I hereby declare:

the specification of which (check one)

My residence, mailing address, and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor or an original, first and joint inventor of the subject matter that is claimed and for which a patent is sought on the invention entitled:

METHOD OF CUTTING MULTILAYER STRUCTURE AND METHOD OF FORMING MULTILAYER CONTAINER AND MULTILAYER PRODUCT

is attached hereto.			
was filed on July 25, 20 on (if applicable)		plication No. <u>PCT/JP2003/009487</u> a	nd was amended
I because a state that I become			£:d£:
including the claims, as am		nd the contents of the above identinent referred to above.	fied specification,
that I know to be material including for continuation-in	al to the patentability n-part applications, ma or application and the	States Patent and Trademark Offi of this application as defined in a aterial information which became a national or PCT international f	37 C.F.R. §1.56, vailable between
application(s) for patent or International application who below and have also iden	inventor's or plant by hich designated at lea htified below, by chec	U.S.C. §119(a)-(d) or (f), or §365(reeder's rights certificate(s), or §36 ast one country other than the Uni king the box, any foreign applicat	55(a) of any PCT ted States, listed ion for patent or
		or PCT International application ha laimed.	ving a filing date
inventor's or plant breeder before that of the application Prior Foreign Application(s)	n on which priority is c		ving a filing date Priority Not Claimed
before that of the applicatio	n on which priority is c		Priority
before that of the application Prior Foreign Application(s) 2002-217342	n on which priority is c : Japan	laimed.	Priority
before that of the application Prior Foreign Application(s) 2002-217342 (Number) (Number)	Japan (Country)	laimed. 07/25/2002 (Filing Date, MM/DD/YYYY)	Priority Not Claimed
before that of the application Prior Foreign Application(s) 2002-217342 (Number) (Number) I hereby claim the benefit	Japan (Country)	laimed.	Priority Not Claimed

I hereby claim the benefit under 35 U.S.C. §120 of any United States applications(s), or §365(c) of any PCT International Application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

PCT/JP2003/009487 (Application Serial No.)	07/25/2003 (Filing Date, MM/DD/YYYY)	Pending (Status: patented, pending, abandoned)
(Application Serial No.)	(Filing Date, MM/DD/YYYY)	(Status: patented, pending, abandoned)
(Application Serial No.)	(Filing Date, MM/DD/YYYY)	(Status: patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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